

MOSFET

INCHARGE

IRF630

N-channel mosfet transistor

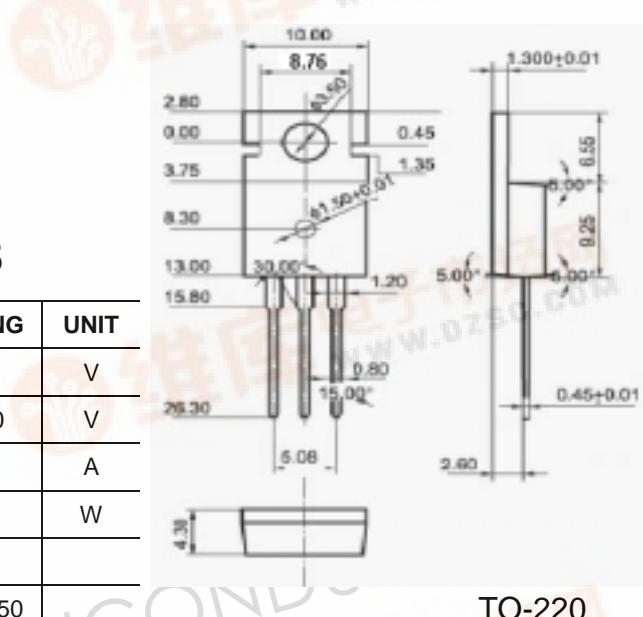


◆ Features

- With TO-220 package
 - Low on-state and thermal resistance
 - Fast switching
 - $V_{DSS}=200V$; $R_{DS(ON)}=0.4\Omega$; $I_D=9A$
 - 1.gate 2.drain 3.source

◆ Absolute Maximum Ratings Tc=25

| SYMBOL | PARAMETER | RATING | UNIT |
|-----------|-------------------------------------|----------|------|
| V_{DSS} | Drain-source voltage ($V_{GS}=0$) | 200 | V |
| V_{GS} | Gate-source voltage | ± 20 | V |
| I_D | Drain Current-continuous@ TC=25 | 9 | A |
| P_{tot} | Total Dissipation@TC=25 | 74 | W |
| T_j | Max. Operating Junction temperature | 150 | |
| T_{stg} | Storage temperature | -65~150 | |



◆ Electrical Characteristics Tc=25

| SYMBOL | PARAMETER | CONDITIONS | MIN | MAX | UNIT |
|---------------|----------------------------------|---|-----|-----------|------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS}=0$; $I_D=0.25\text{mA}$ | 200 | | V |
| $V_{GS(TH)}$ | Gate threshold voltage | $V_{DS}=V_{GS}$; $I_D=1\text{mA}$ | 2 | 4 | V |
| $R_{DS(ON)}$ | Drain-source on-stage resistance | $V_{GS}=10\text{V}$; $I_D=5.4\text{A}$ | | 400 | m |
| I_{GSS} | Gate source leakage current | $V_{GS}=\pm 20\text{V}$; $V_{DS}=0$ | | ± 100 | nA |
| I_{DSS} | Zero gate voltage drain current | $V_{DS}=200\text{V}$; $V_{GS}=0$ | | 10 | uA |
| V_{SD} | Diode forward voltage | $I_F=9\text{A}$; $V_{GS}=0$ | | 1.2 | V |